

# 2.5V Drive Nch MOS FET

## RTF015N03

### ●Structure

Silicon N-channel MOS FET

### ●Features

- 1) Low On-resistance.
- 2) Space saving, small surface mount package (TUMT3).
- 3) Low voltage drive (2.5V drive).

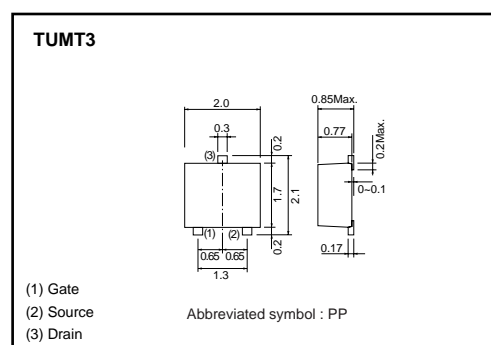
### ●Applications

Switching

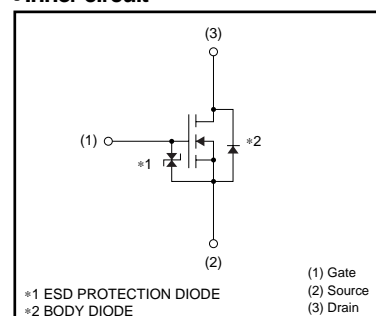
### ●Packaging specifications

| Type      | Package                      | Taping |
|-----------|------------------------------|--------|
|           | Code                         | TL     |
|           | Basic ordering unit (pieces) | 3000   |
| RTF015N03 |                              | ○      |

### ●Dimensions (Unit : mm)



### ●Inner circuit



### ●Absolute maximum ratings (Ta=25°C)

| Parameter                      |            | Symbol      | Limits      | Unit |
|--------------------------------|------------|-------------|-------------|------|
| Drain-source voltage           |            | $V_{DS}$    | 30          | V    |
| Gate-source voltage            |            | $V_{GS}$    | 12          | V    |
| Drain current                  | Continuous | $I_D$       | $\pm 1.5$   | A    |
|                                | Pulsed     | $I_{DP}$ *1 | $\pm 6.0$   | A    |
| Source current<br>(Body diode) | Continuous | $I_S$       | 0.6         | A    |
|                                | Pulsed     | $I_{SP}$ *1 | 6.0         | A    |
| Total power dissipation        |            | $P_D$ *2    | 0.8         | W    |
| Channel temperature            |            | $T_{ch}$    | 150         | °C   |
| Range of storage temperature   |            | $T_{stg}$   | -55 to +150 | °C   |

\*1  $P_W \leq 10 \mu s$ , Duty cycle  $\leq 1\%$

\*2 Mounted on a ceramic board

### ●Thermal resistance

| Parameter          | Symbol           | Limits | Unit |
|--------------------|------------------|--------|------|
| Channel to ambient | $R_{th(ch-a)}$ * | 156    | °C/W |

\* Mounted on a ceramic board

## Transistors

## ●Electrical characteristics (Ta=25°C)

| Parameter                               | Symbol                 | Min. | Typ. | Max. | Unit | Conditions                                    |
|---|------------------------|------|------|------|------|---|
| Gate-source leakage                     | I <sub>GSS</sub>       | —    | —    | 10   | μA   | V <sub>GS</sub> =12V, V <sub>DS</sub> =0V     |
| Drain-source breakdown voltage          | V <sub>(BR) DSS</sub>  | 30   | —    | —    | V    | I <sub>D</sub> = 1mA, V <sub>GS</sub> =0V     |
| Zero gate voltage drain current         | I <sub>DSS</sub>       | —    | —    | 1    | μA   | V <sub>DS</sub> = 30V, V <sub>GS</sub> =0V    |
| Gate threshold voltage                  | V <sub>GS (th)</sub>   | 0.5  | —    | 1.5  | V    | V <sub>DS</sub> = 10V, I <sub>D</sub> = 1mA   |
| Static drain-source on-state resistance | R <sub>DS (on)</sub> * | —    | 170  | 240  | mΩ   | I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 4.5V |
|   |                        | —    | 180  | 250  | mΩ   | I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 4V   |
|   |                        | —    | 240  | 340  | mΩ   | I <sub>D</sub> = 1.5A, V <sub>GS</sub> = 2.5V |
| Forward transfer admittance             | Y <sub>fs</sub>   *    | 1.5  | —    | —    | S    | V <sub>DS</sub> = 10V, I <sub>D</sub> = 1.5A  |
| Input capacitance                       | C <sub>iss</sub>       | —    | 80   | —    | pF   | V <sub>DS</sub> = 10V                         |
| Output capacitance                      | C <sub>oss</sub>       | —    | 14   | —    | pF   | V <sub>GS</sub> =0V                           |
| Reverse transfer capacitance            | C <sub>rss</sub>       | —    | 12   | —    | pF   | f=1MHz  |
| Turn-on delay time                      | t <sub>d (on)</sub> *  | —    | 7    | —    | ns   | V <sub>DD</sub> ≒ 15V                         |
| Rise time                               | t <sub>r</sub> *       | —    | 9    | —    | ns   | I <sub>D</sub> = 0.75A                        |
| Turn-off delay time                     | t <sub>d (off)</sub> * | —    | 15   | —    | ns   | V <sub>GS</sub> = 4.5V                        |
| Fall time                               | t <sub>f</sub> *       | —    | 6    | —    | ns   | R <sub>L</sub> =20Ω                           |
| Total gate charge                       | Q <sub>g</sub> *       | —    | 1.6  | 2.2  | nC   | V <sub>DD</sub> ≒ 15V V <sub>GS</sub> = 4.5V  |
| Gate-source charge                      | Q <sub>gs</sub> *      | —    | 0.5  | —    | nC   | I <sub>D</sub> = 1.5A                         |
| Gate-drain charge                       | Q <sub>gd</sub> *      | —    | 0.3  | —    | nC   | R <sub>L</sub> =10Ω R <sub>G</sub> =10Ω       |

\*Pulsed

## ●Body diode characteristics (Source-drain) (Ta=25°C)

| Parameter       | Symbol          | Min. | Typ. | Max. | Unit | Conditions                                 |
|-----------------|-----------------|------|------|------|------|--|
| Forward voltage | V <sub>SD</sub> | —    | —    | 1.2  | V    | I <sub>S</sub> = 0.6A, V <sub>GS</sub> =0V |

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